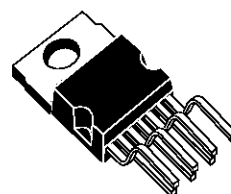


TV VERTICAL DEFLECTION OUTPUT CIRCUIT

- POWER AMPLIFIER
- FLYBACK GENERATOR
- THERMAL PROTECTION

DESCRIPTION

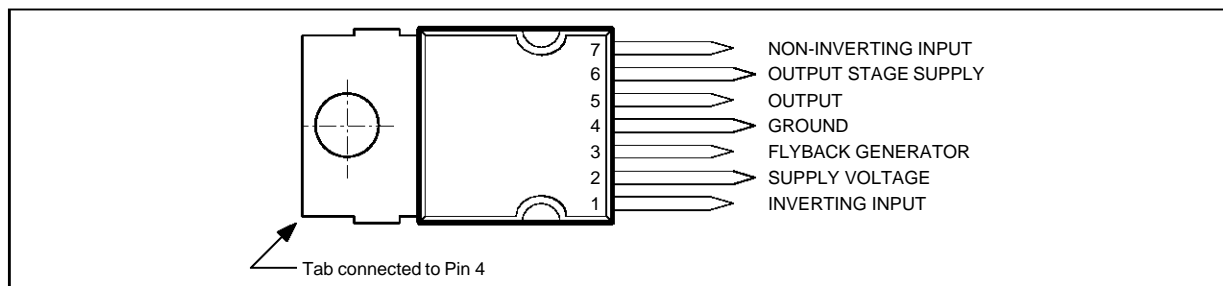
The TDA8172 is a monolithic integrated circuit in HEPTAWATT™ package. It is a high efficiency power booster for direct driving of vertical windings of TV yokes. It is intended for use in Color and B & W television as well as in monitors and displays.



HEPTAWATT
(Plastic Package)

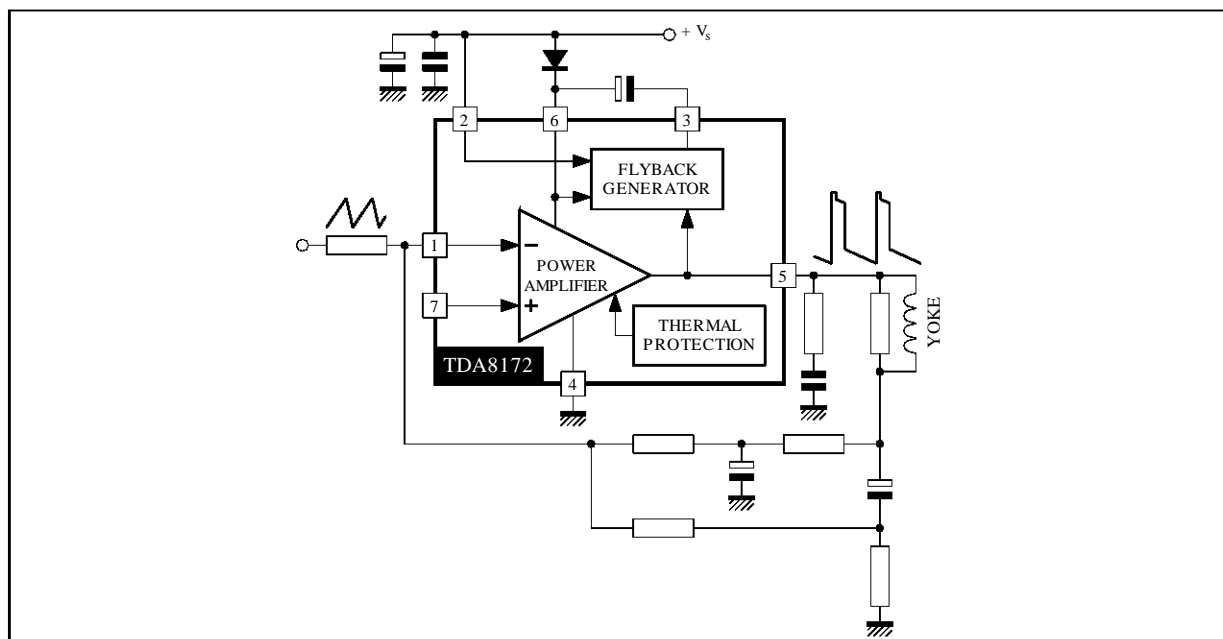
ORDER CODE : TDA8172

PIN CONNECTIONS (top view)



8172-01.EPS

BLOCK DIAGRAM



8172-02.EPS

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_S	Supply Voltage (pin 2)	35	V
V_5, V_6	Flyback Peak Voltage	60	V
V_3	Voltage at Pin 3	+ V_S	
V_1, V_7	Amplifier Input Voltage	+ V_S – 0.5	V
I_o	Output Peak Current (non repetitive, $t = 2$ ms)	2.5	A
I_o	Output Peak Current at $f = 50$ or 60 Hz, $t \leq 10$ μ s	3	A
I_o	Output Peak Current at $f = 50$ or 60 Hz, $t > 10$ μ s	2	A
I_3	Pin 3 DC Current at $V_5 < V_2$	100	mA
I_3	Pin 3 Peak to Peak Flyback Current at $f = 50$ or 60 Hz, $t_{fly} \leq 1.5$ ms	3	A
P_{tot}	Total Power Dissipation at $T_{case} = 90$ °C	20	W
T_{stg}, T_j	Storage and Junction Temperature	– 40, +150	°C

8172-01.TBL

THERMAL DATA

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Thermal Resistance Junction-case	Max. 3	°C/W

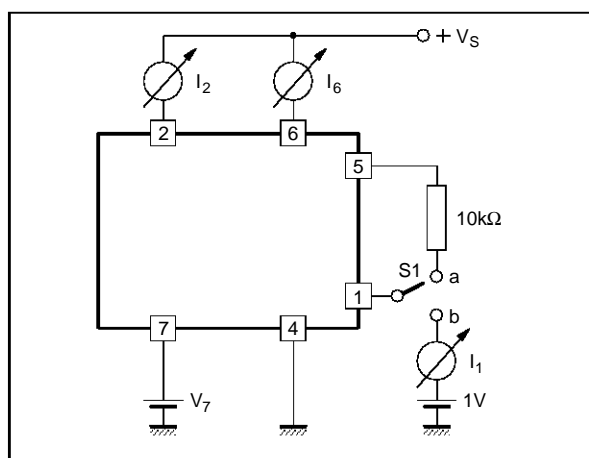
8172-02.TBL

ELECTRICAL CHARACTERISTICS

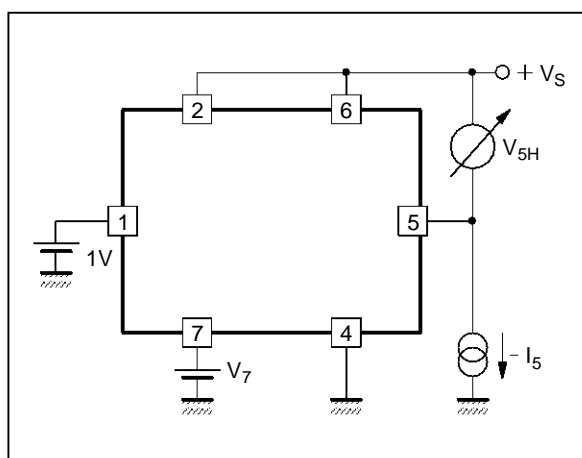
(refer to the test circuits, $V_S = 35$ V, $T_{amb} = 25$ °C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit	Fig.
I_2	Pin 2 Quiescent Current	$I_3 = 0, I_5 = 0$		8	16	mA	1a
I_6	Pin 6 Quiescent Current	$I_3 = 0, I_5 = 0$		16	36	mA	1a
I_1	Amplifier Input Bias Current	$V_1 = 1$ V, $V_7 = 2$ V		– 0.1	– 1	μ A	1a
		$V_1 = 2$ V, $V_7 = 1$ V		– 0.1	– 1	μ A	1a
V_{3L}	Pin 3 Saturation Voltage to GND	$I_3 = 20$ mA		1	1.5	V	1c
V_5	Quiescent Output Voltage	$V_S = 35$ V, $R_a = 39$ k Ω		18		V	1d
V_{5L}	Output Saturation Voltage to GND	$I_5 = 1.2$ A		1	1.4	V	1c
		$I_5 = 0.7$ A		0.7	1	V	1c
V_{5H}	Output Saturation Voltage to Supply	– $I_5 = 1.2$ A		1.6	2.2	V	1b
		– $I_5 = 0.7$ A		1.3	1.8	V	1b
T_j	Junction Temperature for Thermal Shut Down			140		°C	

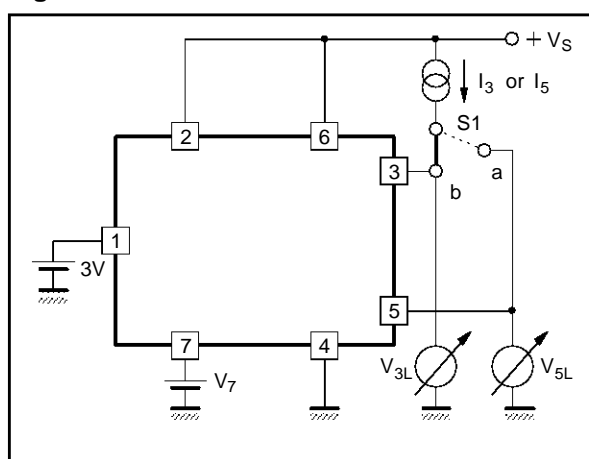
8172-03.TBL

Figure 1 : DC Test Circuits.**Figure 1 a : Measurement of I_1 ; I_2 ; I_6** S₁ : (a) I_2 and I_6 ; (b) I_1

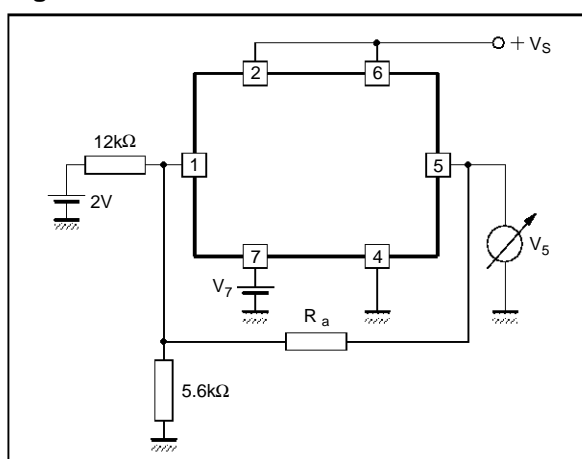
8172-03.EPS

Figure 1 b : Measurement of V_{5H} 

8172-04.EPS

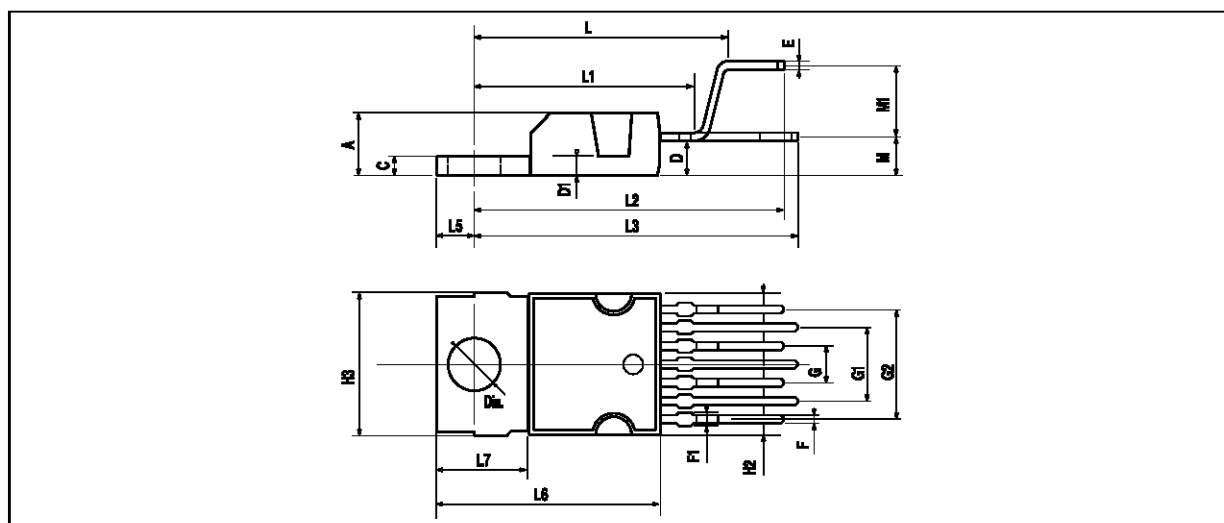
Figure 1 c : Measurement of V_{3L} ; V_{5L} S₁ : (a) V_{3L} ; (b) V_{5L}

8172-05.EPS

Figure 1 d : Measurement of V_5 

8172-06.EPS

PACKAGE MECHANICAL DATA : 9 PINS - PLASTIC HEPTAWATT



PM-HEPTWEP

Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			4.8			0.189
C			1.37			0.054
D	2.4		2.8	0.094		0.110
D1	1.2		1.35	0.047		0.053
E	0.35		0.55	0.014		0.022
F	0.6		0.8	0.024		0.031
F1			0.9			0.035
G	2.41	2.54	2.67	0.095	0.100	0.105
G1	4.91	5.08	5.21	0.193	0.200	0.205
G2	7.49	7.62	7.8	0.295	0.300	0.307
H2			10.4			0.409
H3	10.05		10.4	0.396		0.409
L		16.97			0.668	
L1		14.92			0.587	
L2		21.54			0.848	
L3		22.62			0.891	
L5	2.6		3	0.102		0.118
L6	15.1		15.8	0.594		0.622
L7	6		6.6	0.236		0.260
M		2.8			0.110	
M1		5.08			0.200	
Dia.	3.65		3.85	0.144		0.152

HEPTV/TBL

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